1000-MHz Quadrature Modulator

Description

The IC U2797B is a 1000-MHz quadrature modulator that uses TELEFUNKEN's advanced UHF process. It features a frequency range from 100 MHz up to 1000 MHz, low current consumption, and single-ended RF and LO ports.

The I/Q input impedance is about 150 k Ω . Adjustment free application makes the direct converter suitable for all digital radio systems up to 1000 MHz, e.g., GSM, DAMPS, PDC.

Features

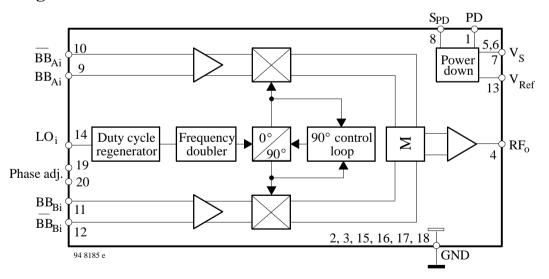
- Supply voltage: 5 V (typical)
- Low power consumption: 30 mA/5 V (typical at -1 dBm output level)
- 150 kΩ I/Q input impedance
- Excellent sideband suppression by means of duty cycle regeneration of the LO input signal
- Phase control loop for precise 90° phase shifting
- Power down mode
- Low LO input level: -10 dBm (typical)

- 50- Ω single-ended LO and RF port
- LO- frequency range of 100 MHz to 1 GHz
- SSO 20 package

Benefits

- Extended talk time due to increased battery life
- Few external components result in cost and board space saving
- Adjustment-free hence saves time

Block Diagram



Ordeing Information

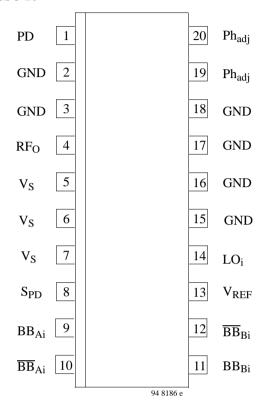
Extended Type Number	Package	Remarks
U2797B-AFS	SSO20	Rail, MOQ 830 pcs.
U2797B-AFSG3	SSO20	Tape & reel, MOQ 4000 pcs.

U2797B

TELEFUNKEN Semiconductors

Pin Description

SSO 20



U2790B-FS (SSO 20)

Pin	Symbol	Function
1	PD	Power down port
2	GND	Ground
3	GND	Ground
4	RF_{o}	RF output
5	V_{S}	Supply voltage
6	V_{S}	Supply voltage
7	V_{S}	Supply voltage
8	S_{PD}	Settling time power down
9	BB_{Ai}	Baseband input A
10	$\overline{\mathrm{BB}}_{\mathrm{Ai}}$	Baseband input A inverse
11	BB_{Bi}	Baseband input B
12	\overline{BB}_{Bi}	Baseband input B inverse
13	V _{REF}	Reference voltage (2.5 V)
14	LOi	LO input
15	GND	Ground
16	GND	Ground
17	GND	Ground
18	GND	Ground
19/20	Ph _{adj}	Phase adjustment (not necessary for regular applications)

Absolute Maximum Ratings

Parameters		Symbol	Value	Unit
Supply voltage	Pins 5, 6 and 7	V_{S}	6	V
Input voltage	Pins 9, 10, 11, 12, 14 and 15	Vi	0 to V _S	V
Junction temperature		T _i	125	°C
Storage temperature range		T _{sto}	-40 to + 125	°C

Operating Range

Parameters	Symbol	Value	Unit
Supply voltage range Pins 5, 6 and 7	V_{S}	4.5 to 5.5	V
Ambient temperature range	T _{amb}	-40 to +85	°C

Thermal Resistance

Parameters		Symbol	Value	Unit
Junction ambient	SSO 20	R _{thia}	140	K/W

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Electrical characteristics

Test conditions (unless otherwise specified): $V_S = 5$ V, $T_{amb} = 25$ °C, referred to test circuit. System impedance $Z_O = 50$ Ω , $f_{LO} = 900$ MHz, $P_{LO} = -10$ dBm, $V_{BBi} = 1$ V_{pp} diff

Parameters	Test conditions / Pin	Symbol	Min.	Тур.	Max.	Unit
Supply voltage range	Pins 5, 6 and 7	V _S	4.5		5.5	V
Supply current	Pins 5, 6 and 7	I _S		30		mA
Baseband inputs	Pins 9-10, 11–12					
Input voltage range (differential)		V_{BBi}		1000	1500	mV _{pp}
Input impedance (single ended)		Z_{BBi}		150		kΩ
Input frequency range		$f_{ m BBi}$	0		200	MHz
LO input	Pin 14					
Frequency range		f_{LOi}	100		1000	MHz
Input level ¹		P _{LOi}	-12	-10	-5	dBm
Input impedance		Z _{iLO}		50		Ω
Voltage standing wave ratio		VSWR _{LO}		1.4	2	_
Duty cycle range		DCR _{LO}	0.4		0.6	_
RF output	Pin 4					
Output level		P _{RFo}	-5	-1		dBm
LO suppression ²	$f_{LO} = 900 \text{ MHz}$ $f_{LO} = 150 \text{ MHz}$	LO _{RFo}	30 32	35 35		dB
Sideband suppression ^{2,3}	$f_{LO} = 900 \text{ MHz}$ $f_{LO} = 150 \text{ MHz}$	SBS _{RFo}	35 30	40 35		dB
Phase error ⁴	20	Pe		< 1		deg.
Amplitude error		A _e		<±0.25		dB
Noise floor	$V_{BBi} = 2 \text{ V}, \overline{V}_{BBi} = 3 \text{ V}$ $V_{BBi} = \overline{V}_{BBi} = 2.5 \text{ V}$	N _{FL}		- 132 - 144		dBm/Hz
VSWR		VSWR _{RF}		1.6	2	
3rd order baseband harmonic suppression		S_{BBH}	35	45		dB
RF harmonic suppression		S _{RFH}		35		dB
Power down mode		10.11		1		•
Supply current	$V_{PD} \le 0.5 \text{ V}$ Pins 4, 5 $V_{PD} = 1 \text{ V}$	I _{PD}		10	1	μΑ
Settling time	$C_{SPD} = 100 \text{ pF}$ $C_{LO} = 100 \text{ pF}$ $C_{RFo} = 1 \text{ nF}$ Pin 6 to 3	t _{sPD}		10		μs
Switching voltage	Pin 1	•		•		
Power on		V _{PDon}	4			V
Power down		V _{PDdown}			1	V
Reference voltage	Pin 13			•		•
Voltage range		V _{Ref}	2.35	2.5	2.65	V
Output impedance		Z _{o Ref}		30		Ω

Note: 1 The required LO level is a function of the LO frequency

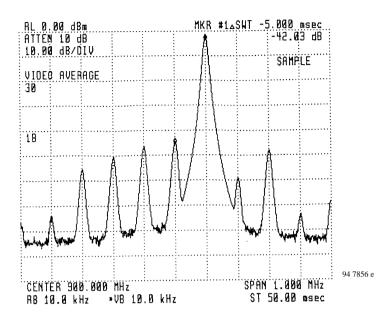
Note: 2 In reference to a RF output level ≤ -1 dBm and I/Q input level of 400 mV_{pp} diff.

Note: 3 Sideband suppression is tested without connection at pins 19 and 20. For higher

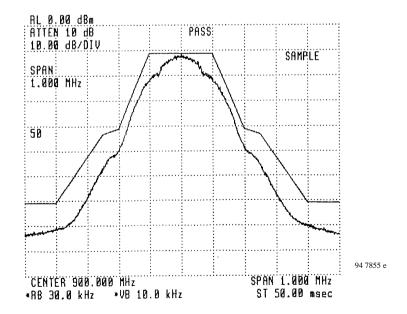
requirements a potentiometer can be connected at these pins.

Note: 4 For $T_{amb} = -40 \text{ to} + 85^{\circ}\text{C}$ and $V_S = 4.5 \text{ to } 5.5 \text{ V}$

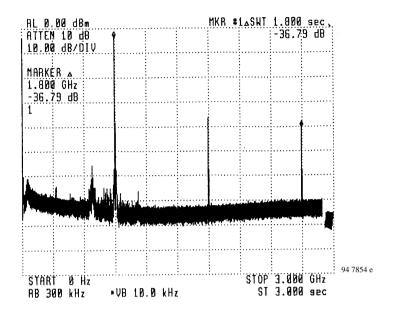
Typical single sideband output spectrum $f_{LO}=900~MHz,\,P_{LO}=-10~dBm,\,V_{BBi}=1~V_{PP}~(differential),\,T_{amb}=25^{\circ}C$

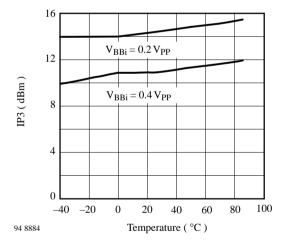


Typical GMSK output spectrum

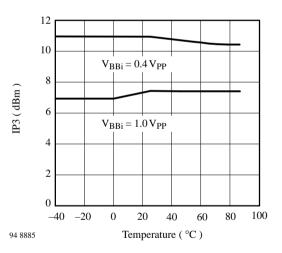


Typical RF-harmonic output spectrum



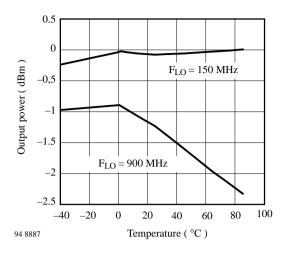


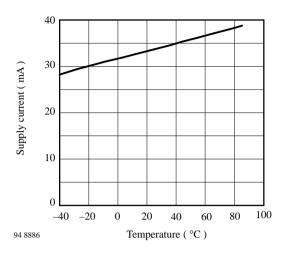




OIP3 vs. T_{amb} , LO = 900 MHz, level – 10 dBm

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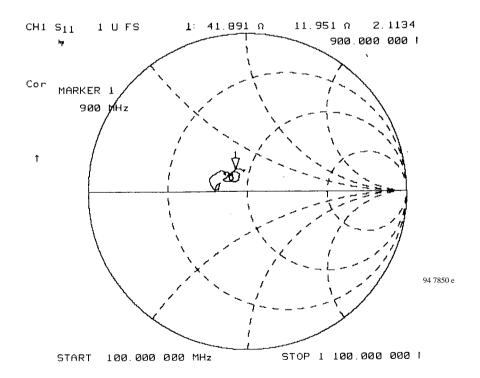




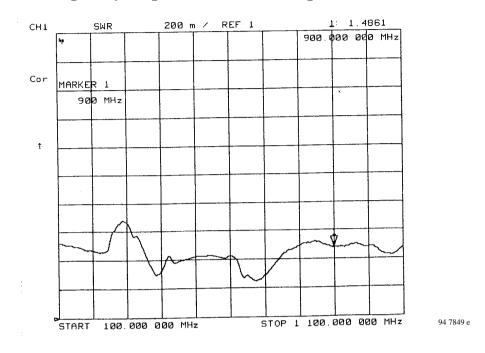
Output power vs. T_{amb}

Supply current vs. Tamb

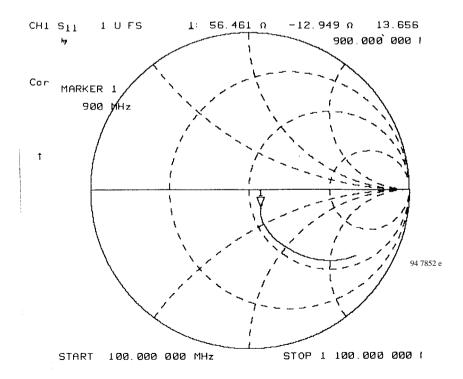
Typical S11 frequency response of the RF output



Typical VSWR frequency response of the RF output

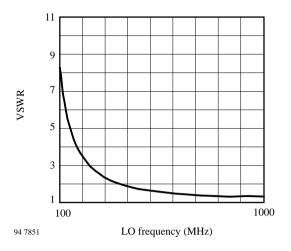


Typical S11 frequency response of the LO input

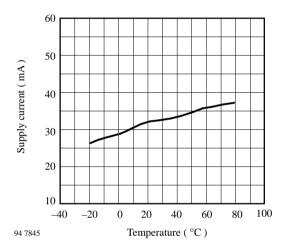


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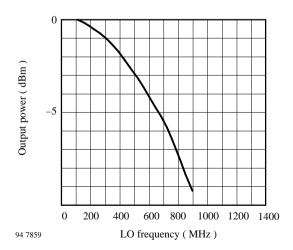
U2797B



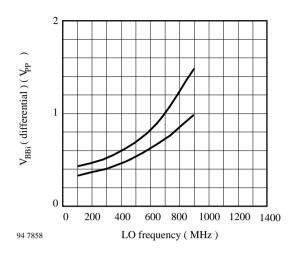
Typical VSWR frequency Response of the LO Input



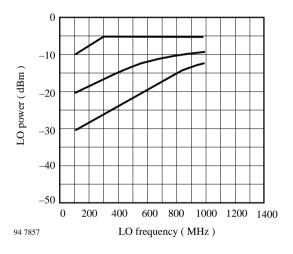
Typical supply current vs. temperature at $V_S = 5 \text{ V}$



Typical output power vs. LO-frequency at $T_{amb} = 25$ °C, $V_{BBi} = 230 \text{ mV}_{PP}$ (differential)



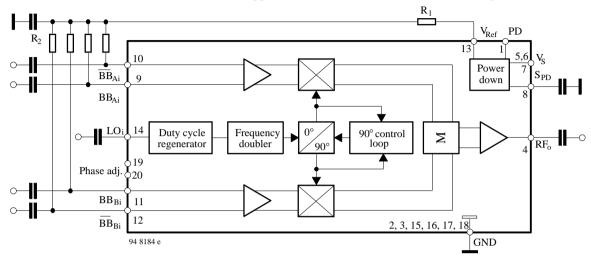
Typical Required V_{BBi} Input Signal (differential) vs. LO Frequency for $P_O=0$ dBm and $P_O=-2$ dBm



Typical useful LO power range vs. LO frequency at $T_{amb} = 25^{\circ}C$

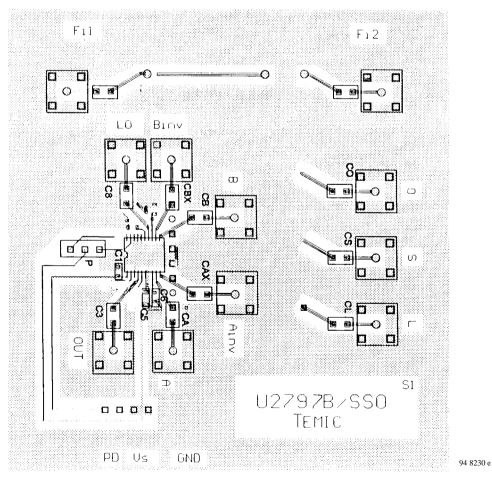
Application circuit

Bias network for ac coupled baseband inputs (V_{BA} , V_{BB}). R1 = 2.5 k Ω , R2 \leq 10 k Ω for \leq 35 dB LO suppression which is in reference to < 2 mV input offset.

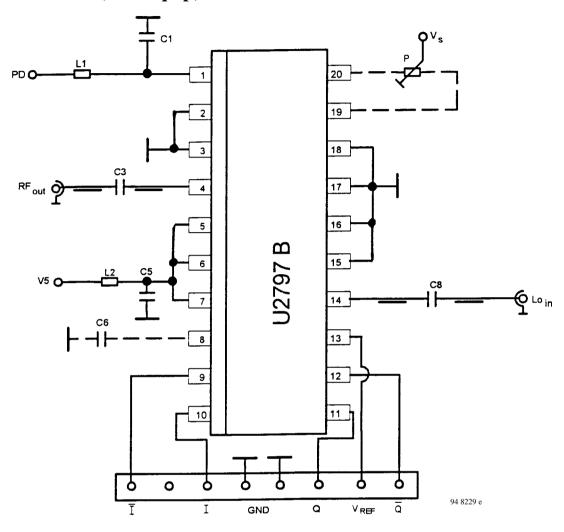


PCB layout

U2797B-FS (SSO 20)



Evaluation circuit (PCB equip)



Part list	
C1, C3, C6	1 nF
C8	100 pF
C5	100 nF
P	Poti 10 kΩ
L1, L2	PCB Inductor
	50 Ω Microstrip
	optional

The above listed components result in a PD settling time of $<\!20~\mu s$. Use of other component values will require consideration of time requirements in burst-mode applications.

Application notes

1. Noise floor and settling time

In order to reduce noise on the power down control input and improve the wide-off noise floor of the 900-MHz RF output signal, capacitor C_{PD} should be connected from pin 8 to ground in the shortest possible way.

The settling time has to be considered for the system under design. For GSM applications a value of $C_{PD}=1~\mu F$ defines a settling time, t_{sPD} , equal or less than 3 μs . This capacitance does not have any influence on the noise floor within the relevant GSM mask. For mobile application

the mask requirements can be achieved very easily without C_{PD}.

A significant improvement of the wide-off noise floor is obtainable with C_{PD} greater than 100 nF. Such values are recommended for applications where the settling time is not critical, such as in base stations. Coupling capacitors for LO_i and RF_O also have a certain impact on the settling time. The values used for the measurements are $C_{LOi} = 100 \ pF$ and $C_{RFo} = 1 \ nF.$

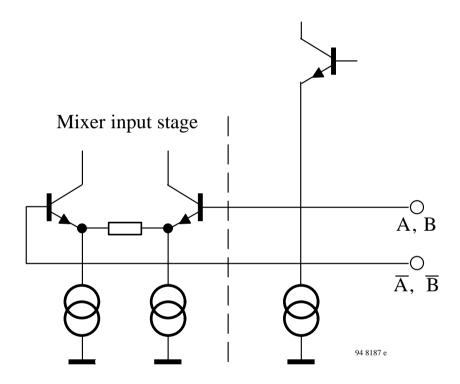
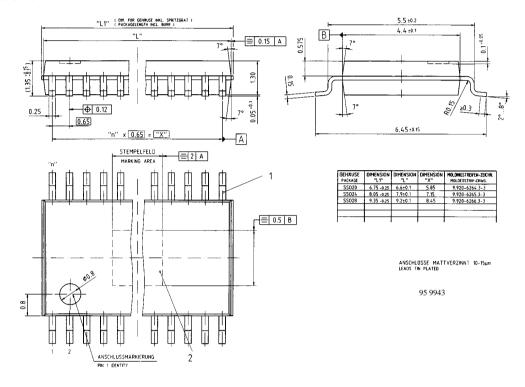


Figure 1 baseband input circuitry

U2797B-FS (SSO 20) has a 150 k Ω baseband input impedance. The reference voltage, V_{REF} , is provided at pin 13.

Dimensions in mm

Package: SSO 20



Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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